# **Tentative**

TOSHIBA Photocoupler GaAs IRED + Photo-Triac

# **TLP261J**

**Triac Drivers** 

**Programmable Controllers** 

**AC-Output Modules** 

Solid-State Relays

The TOSHIBA mini-flat coupler TLP261J is a small-outline coupler suitable for surface mount assembly.

The TLP261J consists of a photo-triac optically coupled to a gallium arsenide infrared-emitting diode.

Peak off-state voltage : 600 V (min)
 Trigger LED current : 10 mA (max)
 On-state current : 70 mA (max)
 Isolation voltage : 3000 Vrms (min)

Zero-crossing function

• UL-recognized : UL1577, file No. E67349

Option (V4) type

VDE-approved : EN60747-5-2 satisfied

Maximum operating insulation voltage : 565 VpK
Highest permissible overvoltage : 6000 Vpk

Note: When an EN60747-5-2 approved type is needed, be sure to specify

"Option (V4)".

Construction Mechanical Rating

Creepage distance : 4.0 mm (min)
Clearance : 4.0 mm (min)
Insulation thickness : 0.4 mm (min)

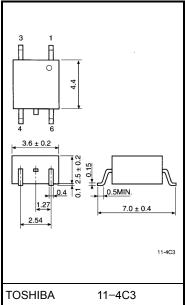
#### **Trigger LED Current**

	Trigger LED	Product	
Classification*	V <sub>T</sub> =3 V,	Classification	
	Min	Max	Marking
(IFT7)	_	7	T7
Standard		10	T7, blank

\*Ex. (IFT7); TLP261J (IFT7)

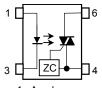
Note: Be sure to use standard product type names when submitting type names for safety certification testing, i.e., TLP261J (IFT7): TLP261J.

Unit: mm



Weight: 0.09 g

#### **Pin Configuration**



1 : Anode

3 : Cathode 4 : Terminal 1

6 : Terminal 2

### **Maximum Ratings (Ta = 25°C)**

	Characteristic		Symbol	Rating	Unit
	Forward current	I <sub>F</sub>	50	mA	
Forward current derating (Ta ≥ 53°C)  Peak forward current (100 µs pulse, 100 pps	Forward current derating (Ta ≥ 53°C)	ΔI <sub>F</sub> / °C	-0.7	mA / °C	
	s)	I <sub>FP</sub>	1	Α	
Reverse voltage  Junction temperature		V <sub>R</sub>	5	V	
		Tj	125	°C	
	Off-state output terminal voltage	$V_{DRM}$	600	V	
Detector	On-state RMS current	Ta = 25°C	<b>I</b>	70	A
		Ta = 70°C	IT(RMS)	40	mA
	On–state current derating (Ta ≥ 25°C)	ΔI <sub>T</sub> / °C	-0.67	mA / °C	
	Peak on-state current (100 µs pulse, 120 p	I <sub>TP</sub>	2	Α	
	Peak nonrepetitive surge current (PW = 10 ms, DC = 10%)	I <sub>TSM</sub>	1.2	А	
	Junction temperature		Tj	100	°C
Storage temperature range			T <sub>stg</sub>	-55~125	°C
Operating temperature range		T <sub>opr</sub>	-40~100	°C	
Lead	d soldering temperature (10 s)		T <sub>sol</sub>	260	°C
Isola	ation voltage (AC, 1 min., R.H ≤ 60%)	(Note 1)	BVS	3000	Vrms

Note 1: Device considered as a two-terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

# **Recommended Operating Conditions**

Characteristic	Symbol	Min	Тур.	Max	Unit
Supply voltage	$V_{AC}$	_	_	240	V <sub>ac</sub>
Forward current	lF	15	20	25	mA
Peak on-state current	I <sub>TP</sub>	_	_	1	Α
Operating temperature	T <sub>opr</sub>	-25	_	85	°C



# Individual Electrical Characteristics (Ta = 25°C)

	Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
	Forward voltage	$V_{F}$	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
LED	Reverse current	I <sub>R</sub>	V <sub>R</sub> = 5 V	_	_	10	μΑ
	Capacitance	C <sub>T</sub>	V = 0, f = 1 MH <sub>Z</sub>	1	30	ı	pF
	Peak off-state current	I <sub>DRM</sub>	V <sub>DRM</sub> = 600 V	_	10	1000	nA
	Peak on-state voltage	$V_{TM}$	I <sub>TM</sub> = 70 mA	_	1.7	2.8	V
ctor	Holding current	lΗ	_	_	0.6	_	mA
Detector	Critical rate of rise of off–state voltage	dv / dt	V <sub>in</sub> = 240 Vrms, Ta = 85°C (Fig. 1)	200	500	_	V/µs
	Critical rate of rise of commutating voltage	dv / dt(c)	V <sub>in</sub> = 60 Vrms, I <sub>T</sub> = 15 mA (Fig. 1)		0.2	_	V/µs

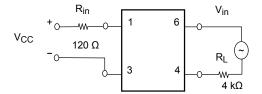
## **Coupled Electrical Characteristics (Ta = 25°C)**

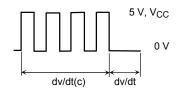
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I <sub>FT</sub>	V <sub>T</sub> = 3 V	_	_	10	mA
Inhibit voltage	V <sub>IH</sub>	I <sub>F</sub> = Rated I <sub>FT</sub>	_	_	20	V
Leakage in inhibited state	lін	I <sub>F</sub> = Rated I <sub>FT</sub> V <sub>T</sub> = Rated V <sub>DRM</sub>	_	200	600	μΑ
Turn-on time	t <sub>ON</sub>	$V_D$ = 3 $\rightarrow$ 1.5 V, R <sub>L</sub> = 20 $\Omega$ I <sub>F</sub> = rated I <sub>FT</sub> × 1.5		30	100	μs

## **Coupled Electrical Characteristics (Ta = 25°C)**

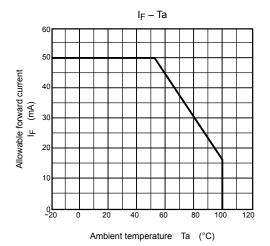
Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance (input to output)	CS	$V_S = 0$ , $f = 1 MH_Z$	_	0.8	_	pF
Isolation resistance	R <sub>S</sub>	V <sub>S</sub> = 500 V, R.H. ≤ 60%	5×10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	AC, 1 minute	3000	_	_	V <sub>rms</sub>
		AC, 1 second, in oil	_	5000	_	
		AC, 1 minute, in oil	_	5000	_	Vdc

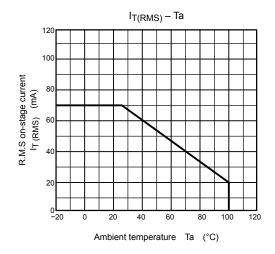
Fig. 1: dv / dt test circuit

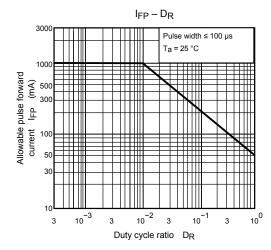


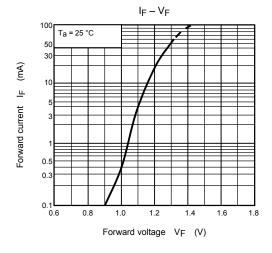


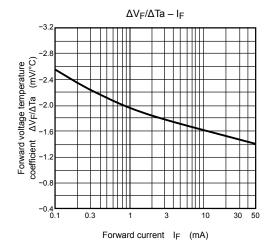
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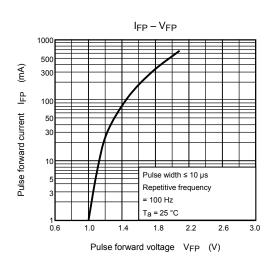




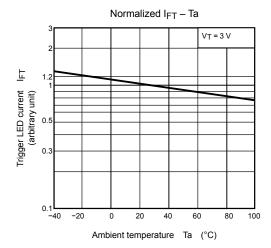


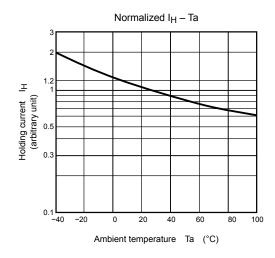


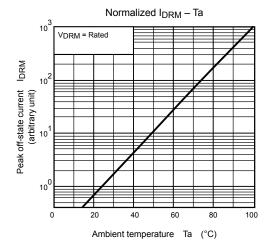


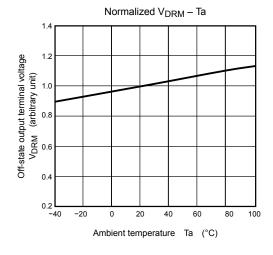


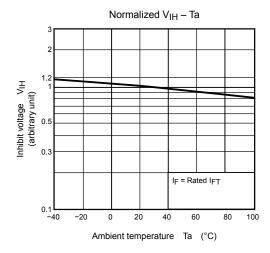
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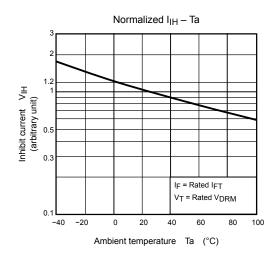












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